

- RF SAW Filter, 921.5 MHz, 13 MHz Bandwidth
- 2.0 x 1.6 x 0.9 mm Surface-mount Case
- Input/Output Impedance $50\Omega/50\Omega$
- Complies with Directive 2002/95/EC (RoHS)
- Complies with AEC-Q200 Qualification Testing

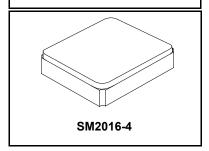


Absolute Maximum Ratings

Rating	Value	Units	
Maximum Incident Power in Passband	+15	dBm	
Maximum DC Voltage on any Non-ground Terminal	3	VDC	
Operating Temperature Range	-40 to +85	°C	
torage Temperature Range in Tape and Reel -40 to +85 °		°C	
Maximum Soldering Profile, 5 Cycles	265 °C	265 °C for 10 s	

SF2259H

921.5 MHz SAW Filter



Electrical Characteristics

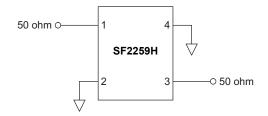
Characteristic	Sym	Notes	Min	Тур	Max	Units
Center Frequency	f _C			921.5		MHz
Maximum Insertion Loss, 915 - 928 MHz	IL _{MAX}			2.0	3.0	
Amplitude Ripple, p-p, 915 - 928 MHz				0.3	1.0	dB
Return Loss, 915 - 928 MHz			10	12		
Group Delay Ripple, 915 - 928 MHz				15	50	ns
Attenuation, Referenced to 0 dB:						
10 to 857.5 MHz			40	52		7
857.5 to 895 MHz			22	45		dB
970 to 1005 MHz			35	40		ub ub
1005 to 1110 MHz			40	56		
1110 to 3000 MHz			30	39		7
Terminating Source impedance	Z _S			50		Ω
Terminating Load impedance	Z _L			50		Ω

Single Ended Input / Output, Impedance match	No matching network required for operation at 50 ohms
Case Style	SM2016-4
Lid Symbolization	3W

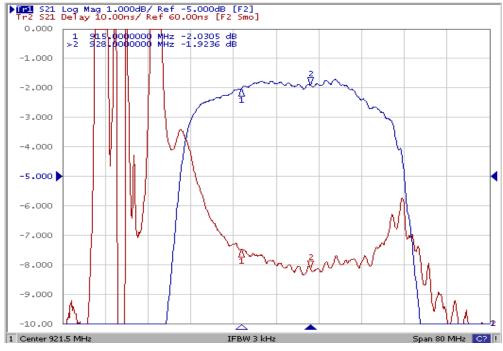
CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

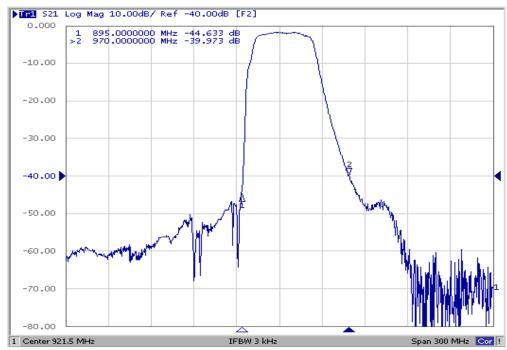
- 1. US and international patents may apply.
- 2. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

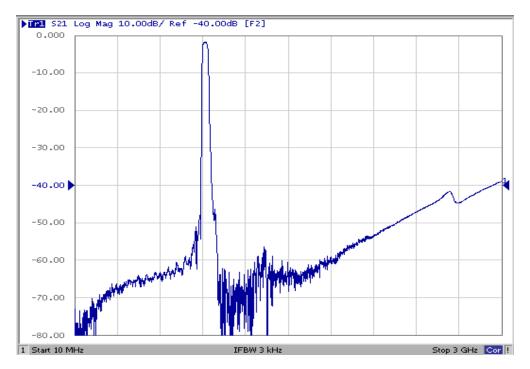
Matching Circuit



Frequency Response Plots

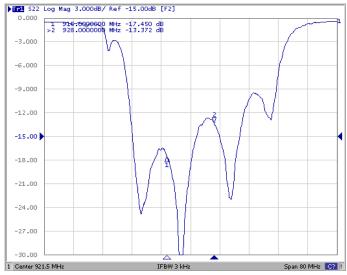






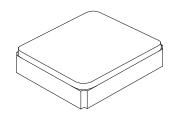
Return Loss Plots



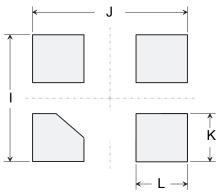


SM2016-4 Case

4-Terminal Ceramic Surface-Mount Case 2.0 X 1.6 mm Nominal Footprint



PCB PAD LAYOUT

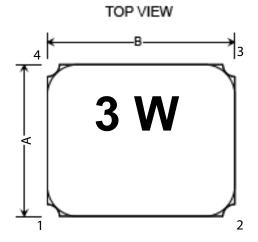


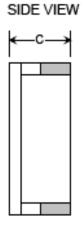
Dimensions in mm
All pads have the same dimensions

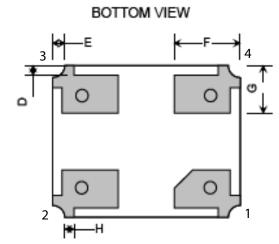
Case Dimensions

Dimension	mm		
	Min	Nom	Max
Α	1.57	1.60	1.73
В	1.97	2.00	2.13
С	0.55	0.65	0.75
D	-	0.10	-
E	-	0.10	-
F	-	0.70	-
G	-	0.50	-
Н	-	0.10	-
I	-	1.80	-
J	-	2.20	-
K	-	0.60	-
L	-	0.80	-

Materials		
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel	
Lid Plating	2.0 to 3.0 µm Nickel	
Body	Al ₂ O ₃ Ceramic	
Pb Free		







1. REEL DIMENSION (Reel Count: 7"=2000 typ.; 13"=10000 typ.)

